

ALPHA-TOP TECHNOLOGY CORP.

APPROVAL SHEET

MODEL NO.:	nSMD 025-30V	
CUSTOMER:		
CUSTOMER'S APPF	ROVAL:	
AUTHORIZED SIGN	ATURE/STAMP:	
DATE		

	MANUFACTURER:	
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-		
	Submitted by: Approved by:	Chen YC Lin

SEA & LAND ELECTRONIC CORP.

21-Feb-22

DATE:

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Features Surface Mount Devices Lead free device

- Size 3.2*1.6 mm/0.12*0.06 inch Surface Mount packaging
 - for automated assembly

Applications

Almost anywhere there is a low voltage power supply, up to 60V and a load to be protected, including: Computer mother board, Modem. USB hub PDAs & Charger, Analog & digital line card Digital cameras, Disk drivers, CD-ROMs,

Alpha-Top (Sea&Land Alliance)

nSMD 025-30V

Performance Specification												
Model	Mandala a a	V _{max}	max	I _{max} I _{hold}	I _{trip}	\mathbf{P}_{d}	Maximum Time To Trip		Resistance		Agency Approval	
Moder	Marking			@25°C	@25°C	Max.	Current	Time	Ri _{min}	R1max	UL	TUV
		(Vdc)	(A)	(A)	(A)	(W)	(A)	(Sec)	(Ω)	(Ω)	02	101
nSMD 025-30V	αA	30	100	0.25	0.50	0.6	8.00	0.08	0.350	2.500	\checkmark	
Ihold = Hold Current.	Maximum cu	urrent device	will not trip	in 25°C still a	air.							
Itrip = Trip Current. I	Minimum curi	rent at which	the device	will always tr	ip in 25°C sti	ll air.						
Vmax = Maximum ope	erating voltag	je device car	n withstand	without dama	age at rated o	urrent (Ima	ıx).					
Imax = Maximum fau	ult current de	vice can with	stand witho	ut damage a	t rated voltag	e (Vmax).						
Pd = Power dissipation when device is in the tripped state in 25°C still air environment at rated voltage.												
Rimin/max = Minimum/Maximum device resistance prior to tripping at 25°C.												
R1 _{max} = Maximum device resistance is measured one hour post reflow.												
CAUTION : Operation	beyond the s	pecified ration	ngs may res	ult in damag	e and possib	le arcing ar	nd flame.					

Environmental Specifications

Test	Conditions	Resistance change				
Passive aging	+85°C, 1000 hrs.	±5% typical				
Humidity aging	+85°C, 85% R.H. , 168 hours	±5% typical				
Thermal shock	+85°C to -40°C, 20 times	±33% typical				
Resistance to solvent	MIL-STD-202, Method 215	No change				
Vibration	MIL-STD-202, Method 201	No change				
Ambient operating conditions :	- 40 °C to 85 °C					
Maximum surface temperature of the device in the tripped state is 125 °C						
In case of special use please contact our engineer						

Agency Approvals :



E201504(Alpha-Top)/E319079(Sea&Land)

Regulation/Standard:



2015/863/EU

EN14582

Ihold Versus Temperature

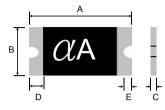
Model		Maximum ambient operating temperature (T_{mao}) vs. hold current (I_{nold})									
Model	-40°C	-20°C	0°C	25°C	40°C	50°C	60°C	70°C	85°C		
nSMD 025-30V	0.370	0.330	0.290	0.250	0.220	0.200	0.170	0.150	0.120		

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Alpha-Top (Sea&Land Alliance)

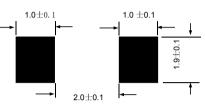
Construction And Dimension (Unit:mm)									
Model		А		В		С		E	
Model	Min.	Max.	Min.	Max.	Min.	Max.	Min.	Min.	
nSMD 025-30V	3.00	3.50	1.50	1.80	0.40	0.90	0.15	0.10	

Dimensions & Marking



 α = Trademark A = Part identification

Recommended Pad Layout (mm)



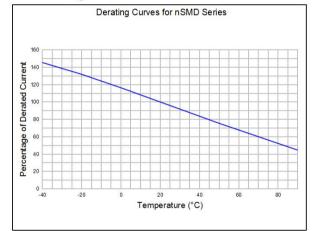
Termination Pad Characteristics

Terminal pad materials : Terminal pad solderability : Rework

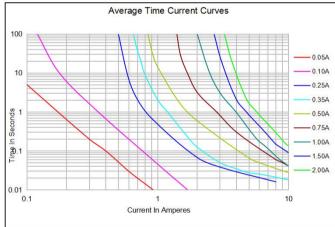
Tin-plated Nickel-Copper Meets EIA specification RS186-9E and ANSI/J-STD-002 Category 3.

Use standard industry practices, the removal device must be replaced with a fresh one.

Thermal Derating Curve



Typical Time-To-Trip At 25°C



WARNING:

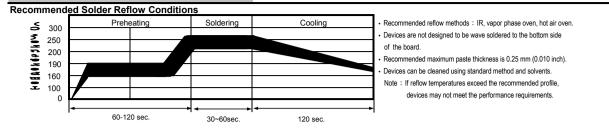
Use PPTC beyond the maximum ratings or improper use may result in device damage and possible electrical arcing and flame.

PPTC are intended for protection against occasional over current or over temperature fault conditions and should not be used when repeated fault conditions or prolonged trip events are anticipated. Device performance can be impacted negatively if devices are handled in a manner inconsistent with recommended electronic, thermal, and mechanical procedures for electronic components.

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Use PPTC with a large inductance in circuit will generate a circuit voltage (L di/dt) above the rated voltage of the PPTC.
Avoid impact PPTC device its thermal expansion like placed under pressure or installed in limited space.
Contamination of the PPTC material with certain silicon based oils or some aggressive solvents can adversely impact the performance of the devices. PPTC SMD can be cleaned by standard methods.
Requests that customers comply with our recommended solder pad layouts and recommended reflow profile. Improper board layouts or reflow profile could negatively impact solderability performance of our devices.

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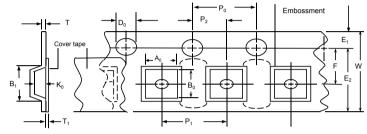
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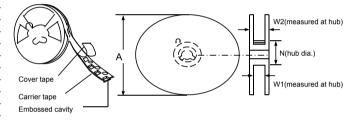
Tape And Reel Specifications (mm)

Governing Specifications	EIA 481-1
W	8.15 ± 0.3
P0	4.0 ± 0.10
P1	4.0 ± 0.10
P2	2.0 ± 0.05
A0	1.95 ± 0.10
B0	3.45 ± 0.10
B1max.	4.35
_D0	1.5 + 0.1, -0
F	3.5 ± 0.05
_E1	1.75 ± 0.10
E2min.	6.25
Tmax.	0.6
T1max.	0.1
<u>K0</u>	1.04 ± 0.1
Leader min.	390
Trailer min.	160
Reel Dimensions	
A max.	178
N min.	60
W1	9 ± 0.5
W2	12.6 ± 0.5

EIA Tape Component Dimensions



EIA Reel Dimensions



Storage And Handling • Storage conditions : 40°C max, 70% R.H.

· Devices may not meet specified performance

if storage conditions are exceeded.

Order Information	Packaging				
nSMD	025-30V	Tape & Reel Quantity			
Product name	Hold				
Size 3216 mm / 1206 inch	Current	5,000 pcs/reel			
SMD : surface mount device	0.25A				

Tape & reel packaging per EIA481-1

Labeling Information

